

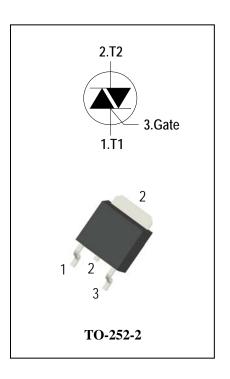
3 Quadrants High temperature Triacs

General Description

High current density due to mesa technology , guaranteed maximum junction temperature 150° C. The ADS8CH triac series is suitable for general purpose AC switching. They can beused as an ON/OFF function in applications such as static relays, heating regulation, High power motor controls e.g. washing machines and vacuum cleaners,Rectifier-fed DC inductive loads e.g.DC motors and solenoids , motor speed controllers. The heatsink can be reduced,compared to traditional triacs, according to the high performance at given junction temperatures.

Features

- ◆ Repetitive Peak Off-State Voltage: 600V/800V
- ◆ R.M.S On-State Current (IT(RMS)= 8A)
- ◆ High Commutation dv/dt
- ◆ High junction temperature operating capability
- ◆ These Devices are Pb-Free and are RoHS Compliant



Absolute Maximum Ratings

Symbol	Items	Conditions		Ratings	Unit
V_{DRM}	Denotitive Deak Off State Voltage	Ti = 25°C	ADS8CH60E	600	V
V_{RRM}	Repetitive Peak Off-State Voltage	Tj = 25°C	ADS8CH80E	800	V
$I_{T(RMS)}$	R.M.S On-State Current	T _C = 125 °C		8	Α
I _{TSM}	Surge On-State Current	tp=20ms(50Hz)/tp=16.7ms(60Hz)		80/84	Α
l ² t	I ² t for fusing	tp=10ms		36	A ² s
-11/-14	Critical rate of rise of on-state $F = 120 \text{ Hz Tj} = 150^{\circ}\text{C}$ current $I_G = 2 \text{ x } I_{GT}$, tr $\leq 100 \text{ ns}$		50	A/μs	
dl/dt					
I_{GM}	Peak Gate Current	tp = 20 μs Tj = 150°C		4	Α
$P_{G(AV)}$	Average Gate Power Dissipation(Tj=150°C)			1	W
P_GM	Peak Gate Power Dissipation(tp=20us,Tj=150°C)			10	W
Tj	Operating Junction Temperature			- 40 ~ 150	°C
T _{STG}	Storage Temperature			- 40 ~ 150	°C



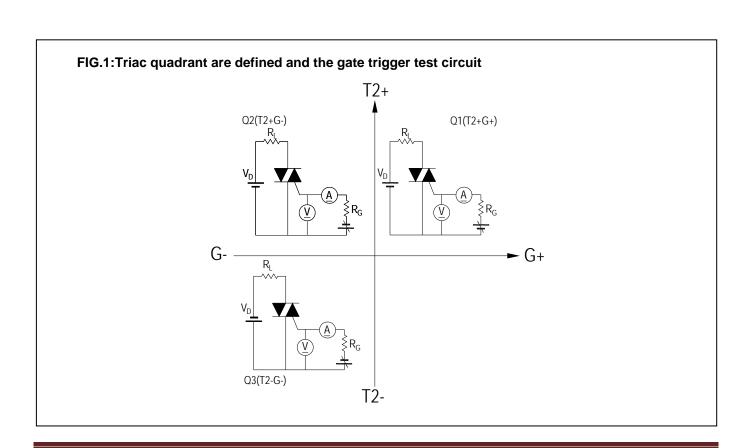


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Electrical Characteristics(Tj = 25°C unless otherwise specified)

Symbol	Items		Conditions		ADS8CH60E/80E			Unit
-					S	Blank	В	
I _{DRM}	Peak Forward Reverse Blocking		$V_{DRM} = V_{RRM}$, $Tj = 25$ °C	May	5		uA	
I _{RRM}	Current		$V_{DRM} = V_{RRM}$, $Tj = 150$ °C	Max.	2.5			mA
V_{TM}	Peak On-S	tate Voltage	I _{TM} = 11A, t _p = 380 μs	Max.	1.5			V
V_{GD}	Q1-Q2-Q3	Non-Trigger Gate Voltage	$V_D = V_{DRM}$ $R_L = 3.3 \text{ k}\Omega$ $Tj = 150^{\circ}\text{C}$	Min.	0.2		>	
V_{GT}	Q1-Q2-Q3	Gate Trigger Voltage	V 40V D 200	Max.	1.5		٧	
I _{GT}	Q1-Q2-Q3	Gate Trigger Current	$V_D = 12V$, $R_L = 33\Omega$ Max.	Max.	10	35	50	mA
I _H	Q1-Q2-Q3	Holding Current	I _T = 0.1A	Max.	20	45	60	mA
	Q1-Q3	Latabina Current	1 - 101	Max.	20	50	70	mA
lι	Q2	Latching Current	I _G = 1.2 I _{GT}		35	70	100	
dV/dt	Critical Rate of Rise of Off-State Voltage		$V_D = 2/3V_{DRM}$ gate open Tj = 150°C	Min.	200	1000	1500	V/µs
(dV/dt)c	Critical Rate of Change of Commutating Voltage		V_D =400V Tj = 150°C (dl/dt)c=-3.5A/ms	Min.	1	15	20	V/µs
R _{th(j-c)}	Junction to case (AC)		Max.	2.5		°C/W		
$R_{th(j-a)}$	Junction to ambient(Copper surface under tab:S=0.5cm ²)		Max.	70		°C/W		



ADV

FIG.2: Maximum on-state power dissipation

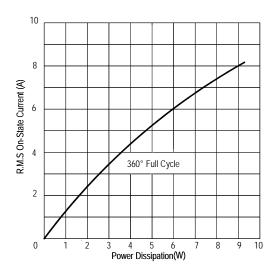


FIG.4: Maximum transient thermal impedance

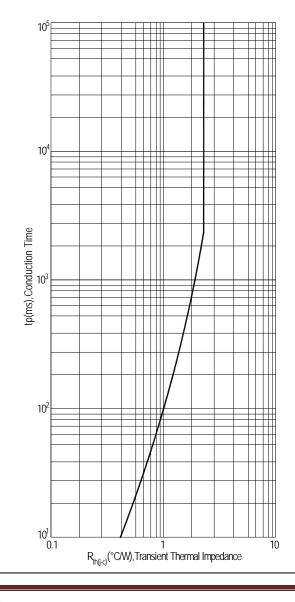


FIG.3: Typical RMS on-state current VS Allowable case Temperature

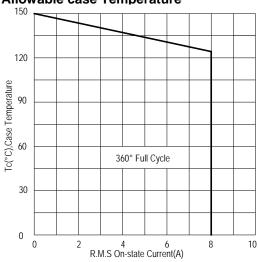


FIG.5: Rated surge on-state current (Non-Repetitive)

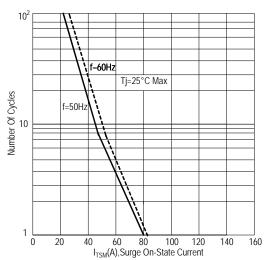
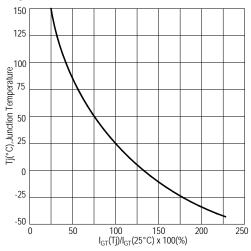


FIG.6: Gate trigger current VS Junction temperature





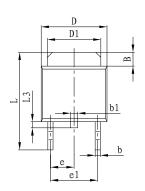
ADS8CH60E/80E

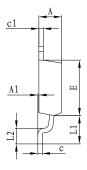
FIG.7:Holding current and Latching current VS FIG.8: Gate trigger voltage VS Junction Junction temperature temperature 150 150 125 125 Tj(°C),Junction Temperature Tj(°C),Junction Temperature -25 -25 -50 -50 100 150 250 50 100 150 $I_{H},I_{L}(Tj)/I_{H},I_{L}(25^{\circ}C) \times 100(\%)$ V_{GT}(Tj)/V_{GT}(25°C) x 100(%) FIG.9: On-state characteristics(Max) 3.5 V_{TM}(V),On-State Voltage 2.5 (1)Tj=25°C Max (2)Tj=125°C Max (1) (2) 0.5 10-1 10^{0} 10¹ 10^{2} I_{TM}(A),On-State Current

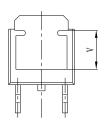




PACKAGE MECHANICAL DATA TO-252-2 Package Dimension







Comple	Dimer	sions	Dimensions		
Symb	In Milli	meters	In Inches		
ol	Min.	Max.	Min.	Max.	
Α	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
В	1.350	1.650	0.053	0.065	
b	0.500	0.700	0.020	0.028	
b1	0.700	0.900	0.028	0.035	
С	0.450	0.620	0.017	0.024	
c1	0.450	0.620	0.017	0.024	
D	6.350	6.650	0.250	0.262	
D1	5.100	5.400	0.200	0.213	
Е	5.900	6.200	0.232	0.244	
е	2.300 TYP.		0.091 TYP.		
e1	4.500	4.700	0.177	0.185	
L	9.500	10.60	0.374	0.396	
L1	2.550	2.900	0.100	0.114	
L2	1.400	1.780	0.055	0.070	
L3	0.600	0.900	0.024	0.035	
V	4.100 REF.		0.161 REF.		

Making Diagram



ADV:Logo ADS8CH60ES:Part number X:Internal control code H:Halogen Free AD S 8 C H 60 E

ADVANCED | Internal control code | Current:8=8A | Quadrant:C=3Q | High temperature:H=150°C | Pa

Sensitivity and type:
S=10mA
Blank=35mA
B=50mA
Package explain:E=TO-252-2
Voltage:60=600V 80=800V

Ordering information

Part number	Package	Marking	Packing	Quantity	
ADS8CH60E#	TO-252-2	ADS8CH60E#	Tube	80pcs	
ADS6CH00E#	10-252-2	ADSoCHOUE#	Embossed tape	2500pcs	
ADS8CH80E#	TO-252-2	ADS8CH80E#	Tube	80pcs	
ADSoCHouE#			Embossed tape	2500pcs	
Note:# = Gate Trigger Current Sensitivity and type					



ADS8CH60E/80E

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